# 2SB1417A

### Silicon PNP epitaxial planar type

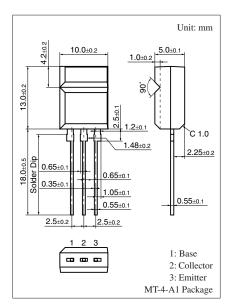
For power amplification Complementary to 2SD2137A

#### Features

- $\bullet$  High forward current transfer ratio  $h_{\text{FE}}$  which has satisfactory linearity
- $\bullet$  Low collector-emitter saturation voltage  $V_{\mbox{CE(sat)}}$
- Allowing automatic insertion with radial taping

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	-80	V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	-80	V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	-6	V
Collector current	I <sub>C</sub>	-3	А
Peak collector current	I <sub>CP</sub>	-5	А
Collector power $T_C = 25^{\circ}C$	P <sub>C</sub>	15	W
dissipation		2.0	
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 ~ +150	°C



#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

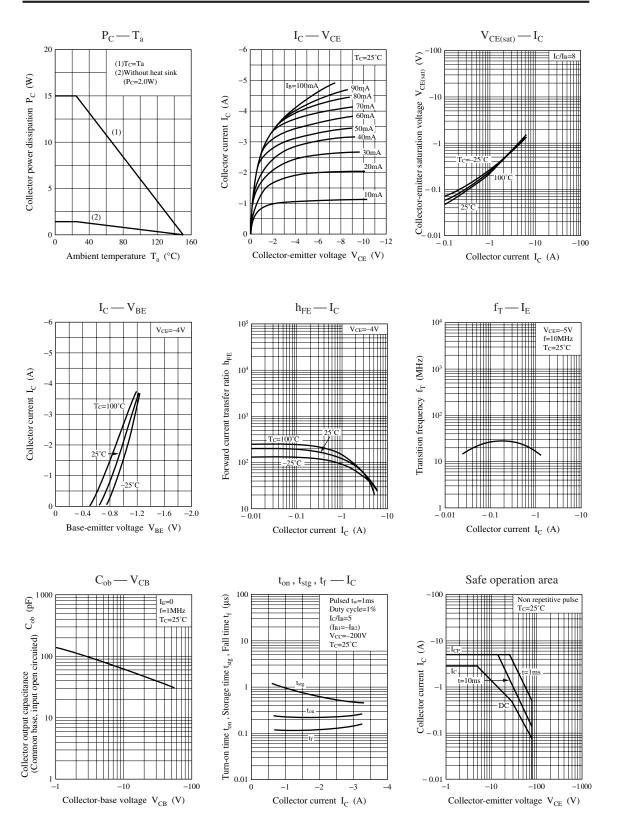
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = -30$ mA, $I_{\rm B} = 0$	-80			V
Base-emitter voltage	V <sub>BE</sub>	$V_{CE} = -4 V, I_C = -3 A$			-1.8	V
Collector-emitter cutoff current (E-B short)	I <sub>CES</sub>	$V_{CE} = -80 \text{ V}, V_{BE} = 0$			-100	μΑ
Collector-emitter cutoff current (Base open)	I <sub>CEO</sub>	$V_{CE} = -60 \text{ V}, I_B = 0$			-100	μΑ
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	$V_{EB} = -6 V, I_C = 0$			-100	μΑ
Forward current transfer ratio	h <sub>FE1</sub> *	$V_{CE} = -4 V, I_C = -1 A$	70		250	—
	h <sub>FE2</sub>	$V_{CE} = -4 V, I_C = -3 A$	10			
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = -3$ A, $I_{\rm B} = -0.375$ A			-1.2	V
Transition frequency	$f_{T}$	$V_{CE} = -5 \text{ V}, I_C = -0.2 \text{ A}, f = 10 \text{ MHz}$		30		MHz
Turn-on time	ton	$I_C = -1 A, I_{B1} = -0.1 A, I_{B2} = 0.1 A$		0.3		μs
Storage time	t <sub>stg</sub>	$V_{CC} = -50 \text{ V}$		1.0		μs
Fall time	t <sub>f</sub>			0.2		μs

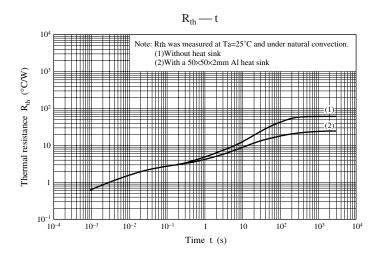
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: Rank classification

Rank	Q	Р
h <sub>FE1</sub>	70 to 150	120 to 250

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